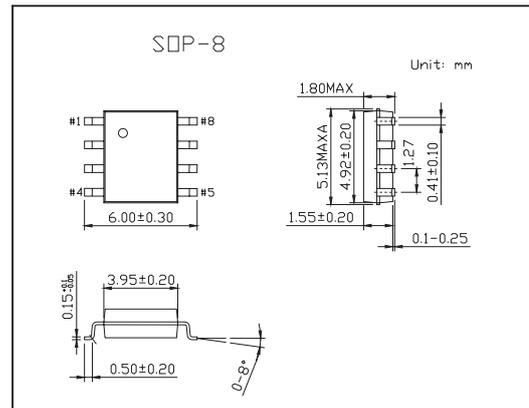
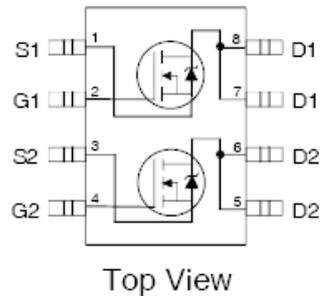


# HEXFET<sup>®</sup> Power MOSFET

## KRF8910

### ■ Features



### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter   | Symbol          | Rating       | Unit                      |
|---|-----------------|--------------|---------------------------|
| Drain- Source Voltage   | $V_{DS}$        | 20           | V                         |
| Gate-to-Source Voltage  | $V_{GS}$        | $\pm 20$     |                           |
| Continuous Drain Current, $V_{GS} @ 10V T_a = 25^\circ\text{C}$ | $I_D$           | 10           | A                         |
| Continuous Drain Current, $V_{GS} @ 10V T_c = 70^\circ\text{C}$ | $I_D$           | 8.3          |                           |
| Pulsed Drain Current *1   | $I_{DM}$        | 82           |                           |
| Maximum Power Dissipation $T_a = 25^\circ\text{C}$              | $P_D$           | 2            | W                         |
| Maximum Power Dissipation $T_a = 70^\circ\text{C}$              |                 | 1.3          |                           |
| Linear Derating Factor  |                 | 0.016        |                           |
| Operating Junction and Storage Temperature Range                | $T_J, T_{STG}$  | -55 to + 150 | $^\circ\text{C}$          |
| Junction-to-Drain Lead  | $R_{\theta JL}$ | 20           | $^\circ\text{C}/\text{W}$ |
| Maximum Junction-to-Ambient *2,3                                | $R_{\theta JA}$ | 62.5         | $^\circ\text{C}/\text{W}$ |
| Single Pulse Avalanche Energy *4                                | $E_{AS}$        | 19           | mJ                        |
| Avalanche Current *1  | $I_{AR}$        | 8.2          | A                         |

\*1 Repetitive rating; pulse width limited by max. junction temperature.

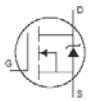
\*2 when mounted on 1 inch square copper board.

\*3  $R_{\theta}$  is measured at  $T_J$  of approximately  $90^\circ\text{C}$

\*4 Starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.57\text{mH}$ ,  $R_G = 25 \Omega$ ,  $I_{AS} = 8.2\text{A}$ .

## KRF8910

## ■ Electrical Characteristics Ta = 25°C

| Parameter   | Symbol                          | Testconditons   | Min   | Typ   | Max  | Unit  |
|---|---------------------------------|---|---|-------|------|-------|
| Drain-to-Source Breakdown Voltage                   | BV <sub>DSS</sub>               | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250A   | 20  |       |      | V     |
| Breakdown Voltage Temp. Coefficient                 | $\Delta V_{(BR)DSS}/\Delta T_J$ | I <sub>D</sub> = 1mA, Reference to 25°C   |   | 0.015 |      | V/°C  |
| Static Drain-to-Source On-Resistance                | R <sub>DS(on)</sub>             | V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A*1   |   | 10.7  | 13.4 | Ω     |
|   |                                 | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 8.0A*1   |   | 14.6  | 18.3 |       |
| Gate Threshold Voltage                              | V <sub>GS(th)</sub>             | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μ A  | 1.65  |       | 2.55 | V     |
| Gate Threshold Voltage Coefficient                  | $\Delta V_{GS(th)}/\Delta T_J$  |   |   | -4.8  |      | mV/°C |
| Drain-to-Source Leakage Current                     | I <sub>DSS</sub>                | V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V   |   |       | 1.0  | μ A   |
|   |                                 | V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C   |   |       | 150  |       |
| Gate-to-Source Forward Leakage                      | I <sub>GSS</sub>                | V <sub>GS</sub> = 20V   |   |       | 100  | nA    |
| Gate-to-Source Reverse Leakage                      |                                 | V <sub>GS</sub> = -20V  |   |       | -100 |       |
| Forward Transconductance                            | g <sub>fs</sub>                 | V <sub>DS</sub> = 10V, I <sub>D</sub> = 8.2A  | 24  |       |      | S     |
| Total Gate Charge                                   | Q <sub>g</sub>                  | I <sub>D</sub> = 8.2A, V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V  |   | 7.4   | 11   | nC    |
| Pre-V <sub>th</sub> Gate-to-Source Charge           | Q <sub>gs1</sub>                |   |   | 2.4   |      |       |
| Post-V <sub>th</sub> Gate-to-Source Charge          | Q <sub>gs2</sub>                |   |   | 0.80  |      |       |
| Gate-to-Drain Charge                                | Q <sub>gd</sub>                 |   |   | 2.5   |      |       |
| Gate Charge Overdrive                               | Q <sub>godr</sub>               |   |   | 1.7   |      |       |
| Switch Charge (Q <sub>gs2</sub> + Q <sub>gd</sub> ) | Q <sub>sw</sub>                 |   |   | 3.3   |      |       |
| Output Charge                                       | Q <sub>oss</sub>                |   | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V |       | 4.4  |       |
| Turn-On Delay Time                                  | t <sub>d(on)</sub>              | V <sub>DD</sub> = 10V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 8.2A  |   | 6.2   |      | ns    |
| Rise Time   | t <sub>r</sub>                  |   |   | 10    |      |       |
| Turn-Off Delay Time                                 | t <sub>d(off)</sub>             |   |   | 9.7   |      |       |
| Fall Time   | t <sub>f</sub>                  |   |   | 4.1   |      |       |
| Input Capacitance                                   | C <sub>iss</sub>                | V <sub>GS</sub> = 0V  |   | 960   |      | pF    |
| Output Capacitance                                  | C <sub>oss</sub>                | V <sub>DS</sub> = 10V   |   | 300   |      |       |
| Reverse Transfer Capacitance                        | C <sub>rss</sub>                | f = 1.0MHz  |   | 160   |      |       |
| Continuous Source Current (Body Diode)              | I <sub>S</sub>                  | MOSFET symbol showing the integral reverse p-n junction diode.  |   |       | 2.5  | A     |
| Pulsed Source Current (Body Diode) *2               | I <sub>SM</sub>                 |   |   |       | 82   |       |
| Diode Forward Voltage                               | V <sub>SD</sub>                 | T <sub>J</sub> = 25°C, I <sub>S</sub> = 8.2A, V <sub>GS</sub> = 0V*1  |   |       | 1.0  | V     |
| Reverse Recovery Time                               | t <sub>rr</sub>                 | T <sub>J</sub> = 25°C, I <sub>F</sub> = 8.2A, V <sub>DD</sub> = 10V   |   | 17    | 26   | ns    |
| Reverse Recovery Charge                             | Q <sub>rr</sub>                 |   | di/dt = 100A/μ s*1                          |       | 6.5  |       |

\*1 Pulse width ≤ 400 μ s; duty cycle ≤ 2%.

\*2 Repetitive rating; pulse width limited by max